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SEMICO	NDUCTOR®	00.	tober 2013				
DP2	572						
	Innel PowerTrench [®] M 29 A, 54 mΩ	OSFET					
eatures		Applications					
 R_{DS(op)} = 	45 mΩ (Typ.) @ V _{GS} = 10 V, I_D = 9 A	Consumer Appliances					
	26 nC (Typ.) @ V _{GS} = 10 V	Consumer AppliancesSynchronous Rectification					
Low Mille		Battery Protection Circuit					
Low Q _{rr} E		Motor drives and Uninterruptible Power Sup	plies				
 UIS Capa 	ability (Single Pulse and Repetitive Pulse)	Micro Solar Inverter					
Formerly dev	elopmental type 82860						
	GDS TO-220	GOLIN					
MOSFE	10-220	GOLIE					
	$G_{D_{S}} = T_{C} = 25^{\circ}C T_{C}$	GOLIE	Unit				
Symbol	T Maximum Ratings T _C = 25°C	unless otherwise noted	Unit V				
Symbol V _{DSS}	T Maximum Ratings T _C = 25°C Parameter	unless otherwise noted					
Symbol V _{DSS}	T Maximum Ratings T _C = 25°C Parameter Drain to Source Voltage Gate to Source Voltage Drain Current	unless otherwise noted FDP2572 150 ±20	V				
Symbol V _{DSS} V _{GS}	ET Maximum Ratings $T_C = 25^{\circ}C$ Parameter Drain to Source Voltage Gate to Source Voltage Drain Current Continuous ($T_C = 25^{\circ}C$, $V_{GS} = 10V$)	unless otherwise noted FDP2572 150 ±20 29	V V A				
Symbol V _{DSS} V _{GS}	T Maximum Ratings $T_C = 25^{\circ}C$ Parameter Drain to Source Voltage Gate to Source Voltage Drain Current Continuous ($T_C = 25^{\circ}C$, $V_{GS} = 10V$) Continuous ($T_C = 100^{\circ}C$, $V_{GS} = 10V$)	unless otherwise noted FDP2572 150 ±20 29 20	V V A A				
Symbol V _{DSS} V _{GS}	T Maximum Ratings $T_C = 25^{\circ}C$ Parameter Drain to Source Voltage Gate to Source Voltage Drain Current Continuous ($T_C = 25^{\circ}C$, $V_{GS} = 10V$) Continuous ($T_C = 100^{\circ}C$, $V_{GS} = 10V$) Continuous ($T_{amb} = 25^{\circ}C$, $V_{GS} = 10V$, $R_{\theta,J}$	unless otherwise noted	V V A A A A				
Symbol V _{DSS} V _{GS}	Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total T	unless otherwise noted	V V A A A A A				
	ET Maximum Ratings $T_C = 25^{\circ}C$ Parameter Drain to Source Voltage Gate to Source Voltage Drain Current Continuous ($T_C = 25^{\circ}C$, $V_{GS} = 10V$) Continuous ($T_C = 100^{\circ}C$, $V_{GS} = 10V$) Continuous ($T_{amb} = 25^{\circ}C$, $V_{GS} = 10V$, $R_{\theta J}$ Pulsed Single Pulse Avalanche Energy (Note 1)	Interse otherwise noted FDP2572 150 150 120 29 20 A = 43°C/W) 4 Figure 4 36	V V A A A A mJ				
Symbol V _{DSS} V _{GS}	Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total Total T	unless otherwise noted	V V A A A A A				

$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	1.11	°C/W
R_{\thetaJA}	Thermal Resistance, Junction to Ambient, Max. (Note 2)	62.5	°C/W

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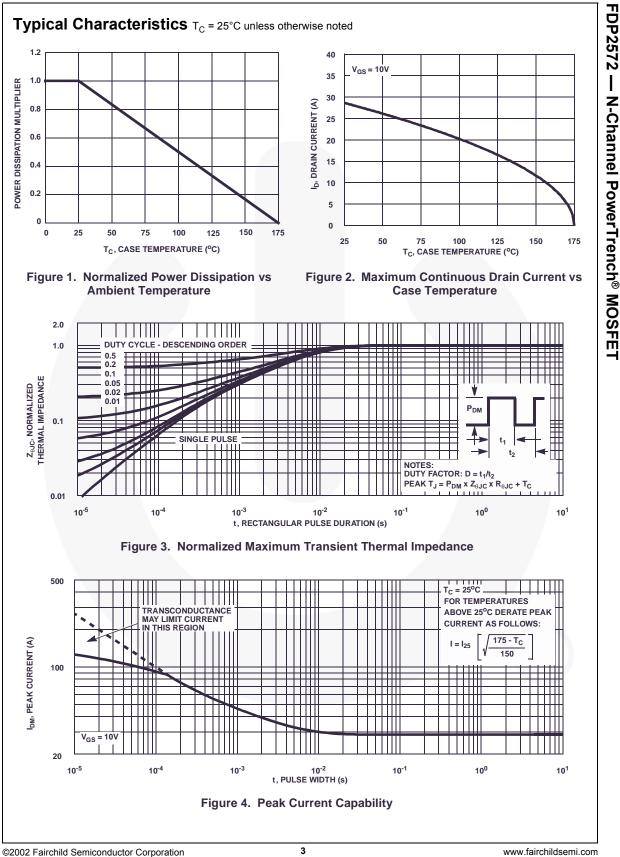
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Device Marking FDP2572		Device	Package F		eel Size	Tape Width		Quantity	
		FDP2572	TO-220		Tube	N/A		50 units	
Electrica	al Char	acteristics T _C = 25°C	unless otherwi	se no	ted				
Symbol		Parameter	Test	Conc	litions	Min	Тур	Max	Unit
Off Chara	cteristic	S							
B _{VDSS}	Drain to S	ource Breakdown Voltage	I _D = 250μA, V _{GS} = 0V			150	-	-	V
	Zero Cate	e Voltage Drain Current	V _{DS} = 120V			-		1	μΑ
200		ç	V _{GS} = 0V		T _C = 150 ^o	-		250	
I _{GSS}	Gate to S	ource Leakage Current	V _{GS} = ±20\	/		-	-	±100	nA
On Chara	cteristic	5							
V _{GS(TH)}	Gate to S	ource Threshold Voltage	V _{GS} = V _{DS}	V _{GS} = V _{DS} , I _D = 250µA				4	V
r _{DS(ON)}			I _D = 9A, V _G	_S = 10	V	-	0.045	0.054	
	Drain to S	ource On Resistance	I _D = 4A, V _C			-	0.050	0.075	Ω
			I _D =9A, V _{GS}	I _D =9A, V _{GS} =10V, T _C =175°C			0.126	0.146	
Dynamic	Characte	eristics							
C _{ISS}	Input Cap					-	1770	-	pF
C _{OSS}		apacitance	V _{DS} = 25V	V _{GS}	= 0V,	-	183	-	pF
C _{RSS}	Reverse T	Fransfer Capacitance	f = 1MHz			1	40	-	pF
Q _{g(TOT)}	-	e Charge at 10V	V _{GS} = 0V t	o 10V		-	26	34	nC
Q _{g(TH)}	Threshold	Gate Charge			V _{DD} = 75V	-	3.3	4.3	nC
Q _{gs}	Gate to S	ource Gate Charge			$I_D = 9A$	-	8	-	nC
Q _{gs2}	Gate Cha	rge Threshold to Plateau			$I_{g} = 1.0 \text{mA}$	-	5	-	nC
Q _{gd}	Gate to D	rain "Miller" Charge				-	6	-	nC
Desistive	Cwitchir	characteristics	401/0					· · · · ·	
		ng Characteristics (V _G	_{SS} = 10V)					26	
t _{ON}	Turn-On T					· ·	-	36	ns
t _{d(ON)}		Delay Time		_			11 14	-	ns
t _r	Rise Time			V_{DD} = 75V, I_D = 9A V_{GS} = 10V, R_{GS} = 11.0 Ω			31	-	ns
t _{d(OFF)}		Delay Time	V _{GS} = 10V			-	14	-	ns
t _f	Fall Time Turn-Off 1	Timo		-			14	- 66	ns
t _{OFF}		line				-	-	00	ns
Drain-Soເ	irce Dioc	le Characteristics							
	Source to	Drain Diode Voltage	I _{SD} = 9A			-	-	1.25	V
Vod		-	I _{SD} = 4A			-	-	1.0	V
		Recovery Time	I_{SD} = 9A, d I_{SD} /dt =100A/µs			-	-	74	ns
V _{SD} t _{rr} Q _{RR}		Recovered Charge	I_{SD} = 9A, d I_{SD} /dt =100A/µs			-	-	169	nC

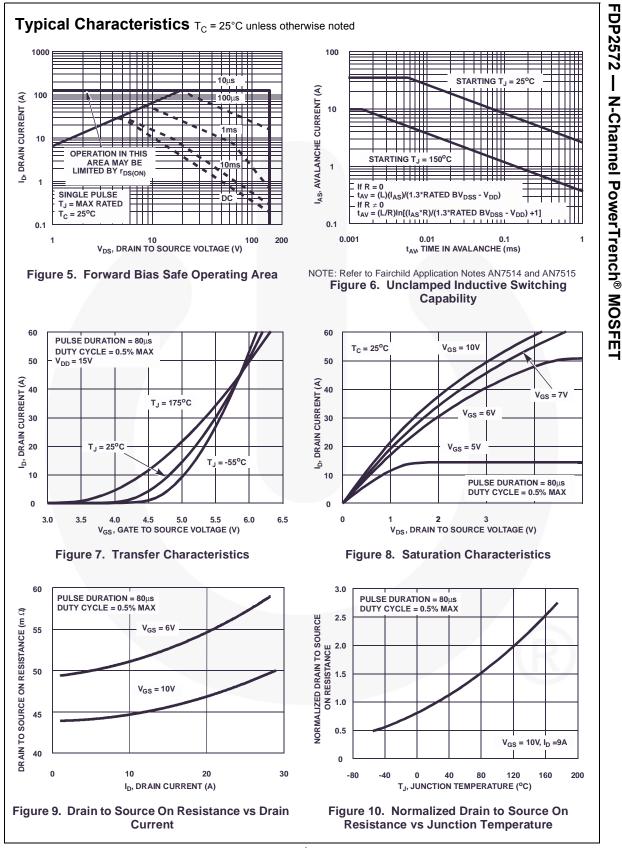
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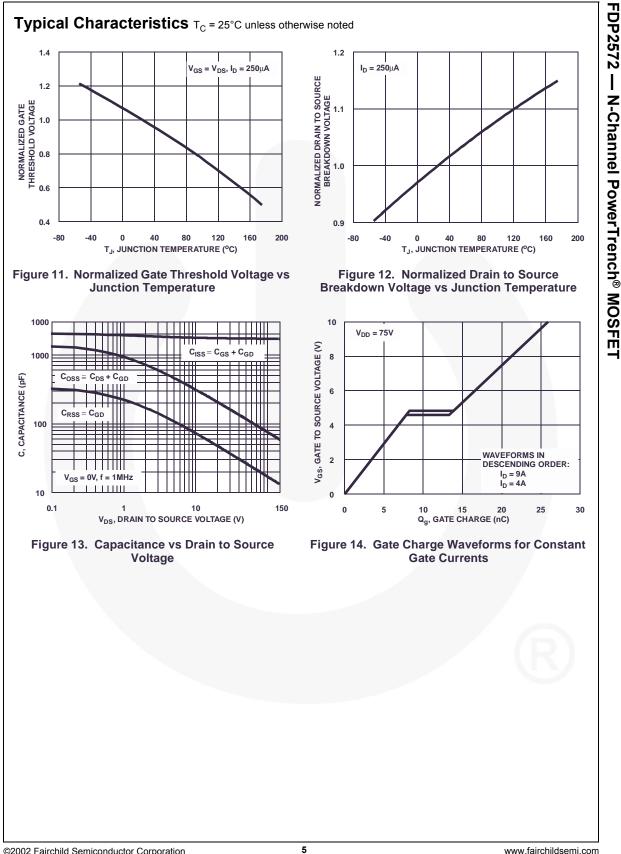


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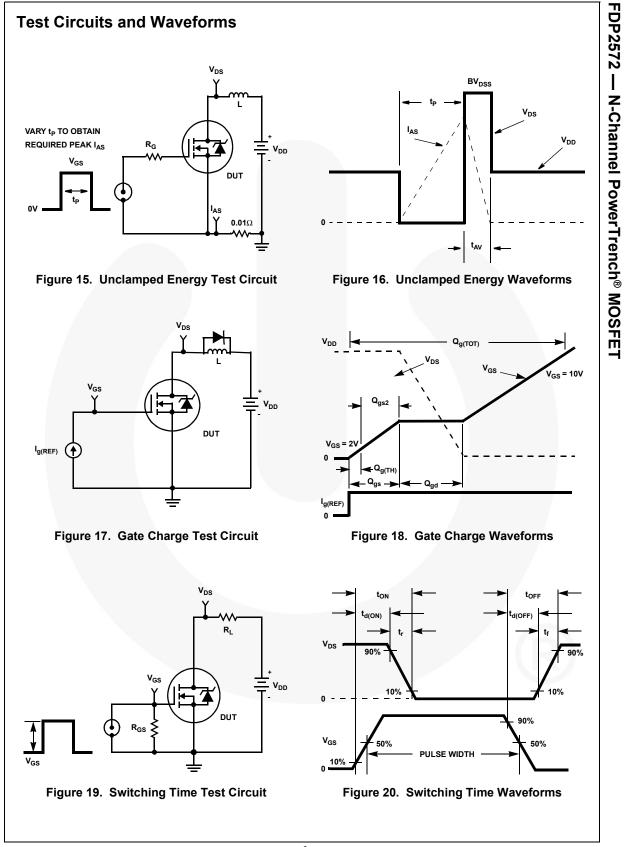


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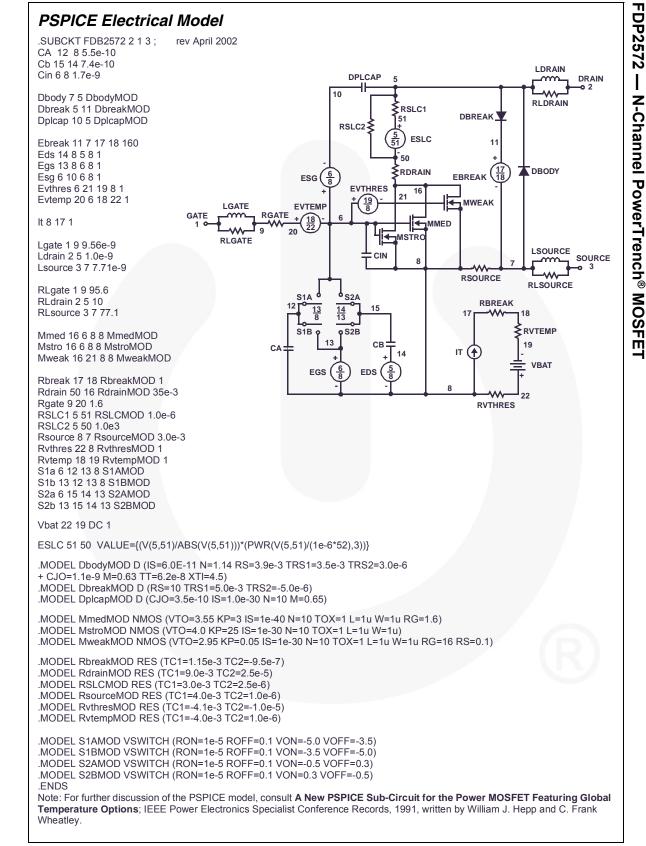


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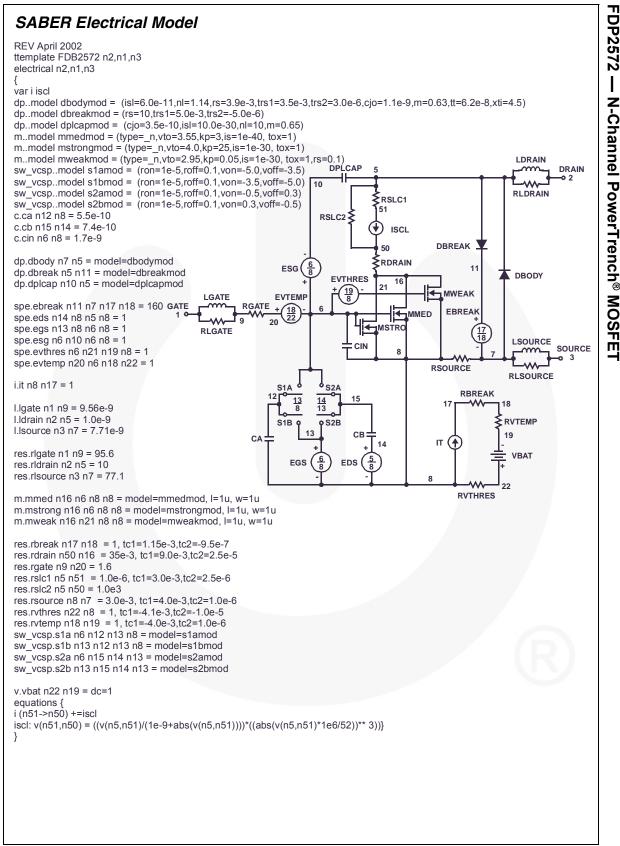
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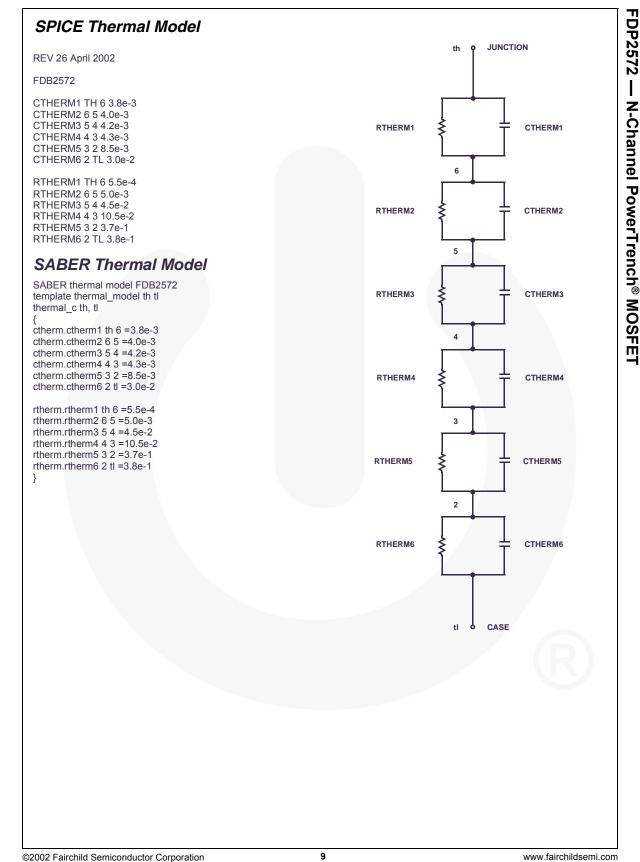
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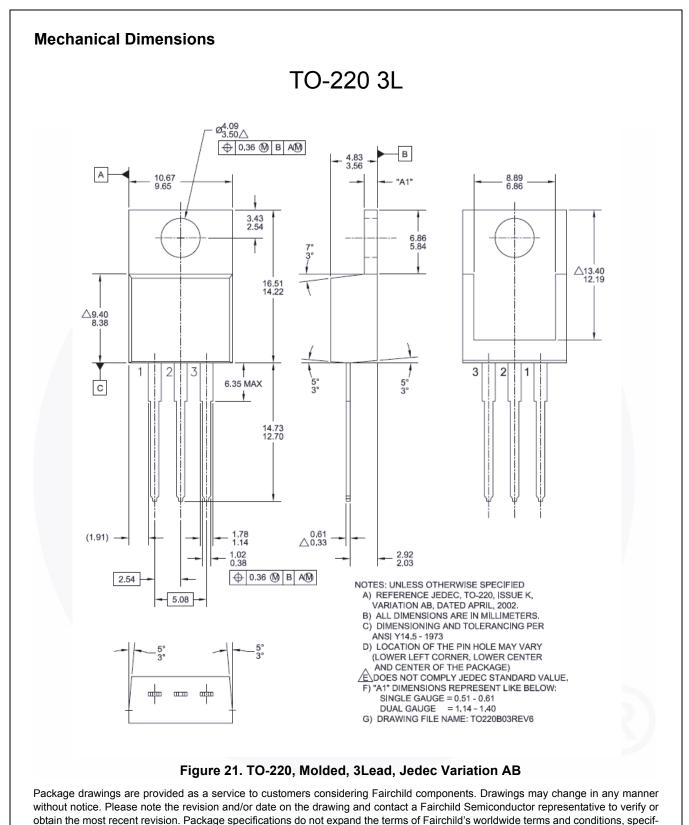
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Dimension in Millimeters



Rev. 166

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